



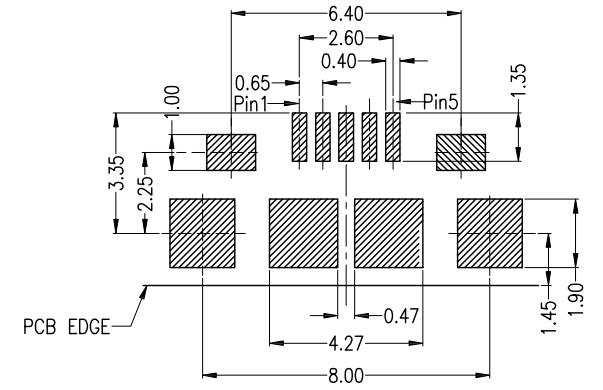
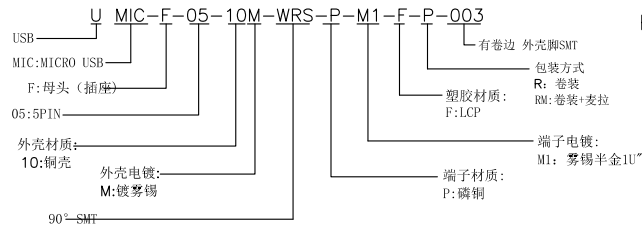
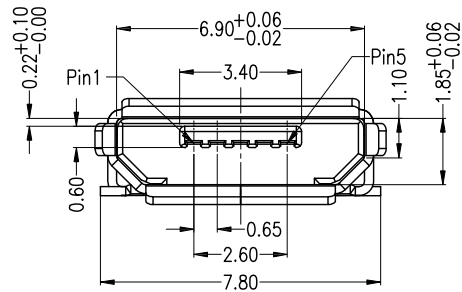
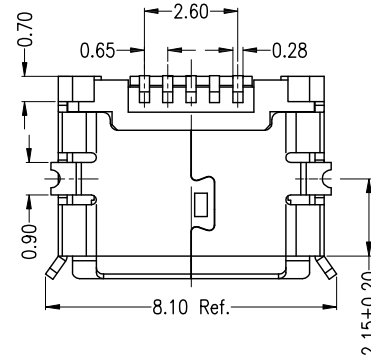
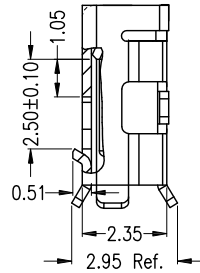
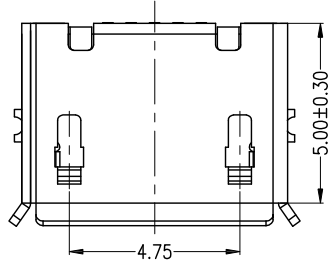
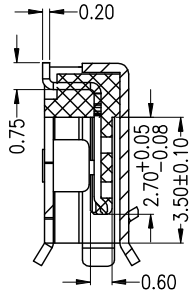
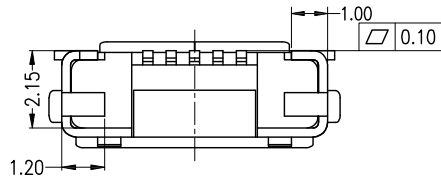
Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min
- 2.7 Temperature range: -30°C~80°C



RECOMMENDED PCB LAYOUT PCB图仅供参考

TOLERANCE UNLESS OTHERWISE SPECIFIED		BZOOC 东莞市柏洲电子有限公司 Dongguan BzooC Electronics, Ltd	
.X± 0.35	X.*± 1.5'	APR. AX.T	TITLE: Micro usb 5P 母座 90° SMT 有卷边 外壳脚SMT
.XX± 0.25	.X*± 1.0'	CHK. Y.L	PART NO.
.XXX± 0.15	.XX*± 0.5'	DRA. Y.L	PROJ. UNITS: MM SCALE: 1:1 SHEET. 1 / 1
REV.	ECN. NO.	APR.	CUSTOMER DRAWING

A0	FIRST RELEASE	Y.L	2019.06.21
REV.	ECN. NO.	APR.	DATE